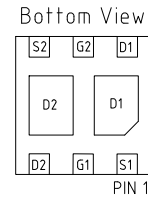
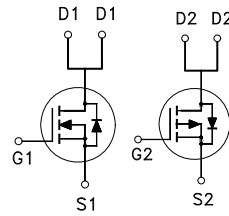


N & P-Channel Logic Level Enhancement Mode Field Effect Transistor

Product Summary:

	N-CH	P-CH
BV_{DSS}	20V	-20V
$R_{DS(on) (MAX.)}$	45m Ω	100m Ω
I_D	4.8A	-3.4A



Pb-Free Lead Plating & Halogen Free



ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS		UNIT
Gate-Source Voltage		V_{GS}	N-CH	P-CH	V
			± 12	± 12	
Continuous Drain Current	$T_A = 25\text{ }^\circ\text{C}$	I_D	4.8	-3.4	A
	$T_A = 70\text{ }^\circ\text{C}$		3.8	-2.7	
Pulsed Drain Current ¹		I_{DM}	19.2	-13.6	
Power Dissipation	$T_A = 25\text{ }^\circ\text{C}$	P_D	1.9		W
	$T_A = 70\text{ }^\circ\text{C}$		1.2		
Operating Junction & Storage Temperature Range		T_{j}, T_{stg}	-55 to 150		$^\circ\text{C}$

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	$R_{\theta JC}$		15	$^\circ\text{C} / \text{W}$
Junction-to-Ambient ³	$R_{\theta JA}$		65	

¹Pulse width limited by maximum junction temperature.

²Duty cycle $\leq 1\%$

³65 $^\circ\text{C} / \text{W}$ when mounted on a 1 in² pad of 2 oz copper.



ELECTRICAL CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$ $V_{GS} = 0V, I_D = -250\mu A$	N-CH	20		V
			P-CH	-20		
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$ $V_{DS} = V_{GS}, I_D = -250\mu A$	N-CH	0.4	0.75	1.2
			P-CH	-0.3	-0.75	-1.2
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 12V$ $V_{DS} = 0V, V_{GS} = \pm 12V$	N-CH			± 100
			P-CH			± 100
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 16V, V_{GS} = 0V$ $V_{DS} = -16V, V_{GS} = 0V$	N-CH			1
			P-CH			-1
			N-CH			10
			P-CH			-10
On-State Drain Current ¹	$I_{D(ON)}$	$V_{DS} = 5V, V_{GS} = 4.5V$ $V_{DS} = -5V, V_{GS} = -4.5V$	N-CH	4.8		A
			P-CH	-3.4		
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 4.5V, I_D = 3.5A$ $V_{GS} = -4.5V, I_D = -3A$ $V_{GS} = 2.5V, I_D = 2A$ $V_{GS} = -2.5V, I_D = -2A$	N-CH		36	45
			P-CH		83	100
			N-CH		43	60
			P-CH		110	135
Forward Transconductance ¹	g_{fs}	$V_{DS} = 5V, I_D = 3.5A$ $V_{DS} = -5V, I_D = -3A$	N-CH		5	S
			P-CH		4.5	
DYNAMIC						
Input Capacitance	C_{iss}	N-CH $V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$	N-CH		355	pF
			P-CH		420	
Output Capacitance	C_{oss}	P-CH $V_{GS} = 0V, V_{DS} = -15V, f = 1MHz$	N-CH		56	pF
			P-CH		56	
Reverse Transfer Capacitance	C_{rss}		N-CH		40	pF
			P-CH		42	



Total Gate Charge ^{1,2}	Q_g	N-CH $V_{DS} = 10V, V_{GS} = 4.5V,$ $I_D = 5A$ P-CH $V_{DS} = -10V, V_{GS} = -4.5V,$ $I_D = -3A$	N-CH		4.6		nC	
Gate-Source Charge ^{1,2}	Q_{gs}		P-CH		5.4			
Gate-Drain Charge ^{1,2}	Q_{gd}		N-CH		0.66			
			P-CH		0.75			
Turn-On Delay Time ^{1,2}	$t_{d(on)}$		N-CH		8			nS
			P-CH		10			
Rise Time ^{1,2}	t_r	$I_D = 1A, V_{GS} = 4.5V, R_{GS} = 6\Omega$	N-CH		10			
			P-CH		20			
Turn-Off Delay Time ^{1,2}	$t_{d(off)}$		P-CH $V_{DS} = -10V,$ $I_D = -1A, V_{GS} = -4.5V, R_{GS} = 6\Omega$	N-CH		20		
				P-CH		15		
Fall Time ^{1,2}	t_f	N-CH			15			
		P-CH			12			
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_c = 25\text{ }^\circ\text{C}$)								
Continuous Current	I_S		N-CH			2	A	
			P-CH			-2		
Pulsed Current ³	I_{SM}		N-CH			8		
			P-CH			-8		
Forward Voltage ¹	V_{SD}		$I_F = I_S, V_{GS} = 0V$	N-CH			1.3	V
				P-CH			-1.3	

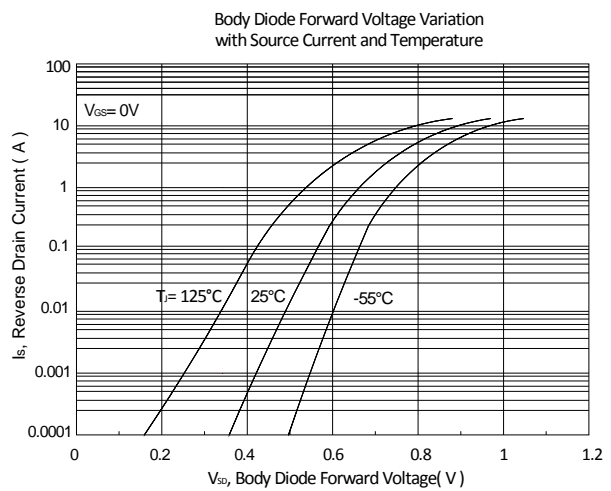
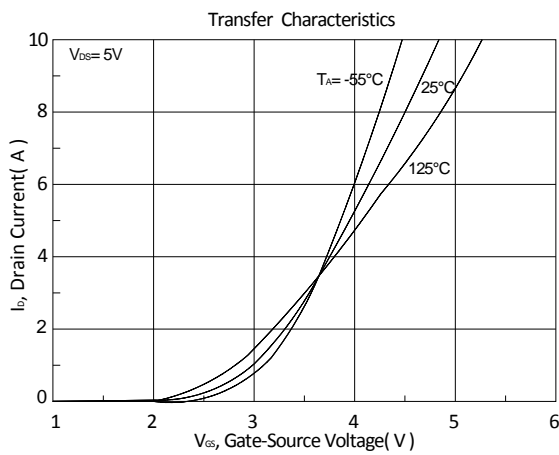
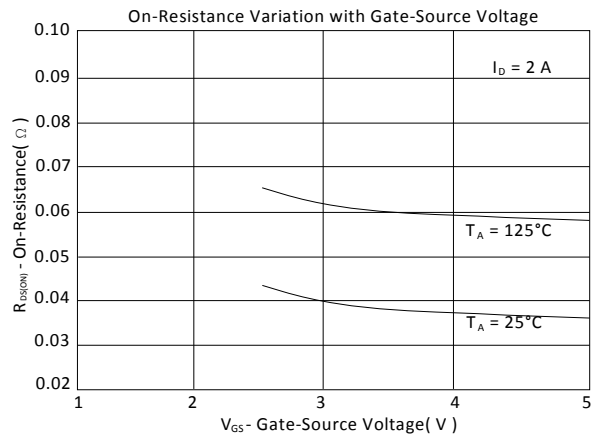
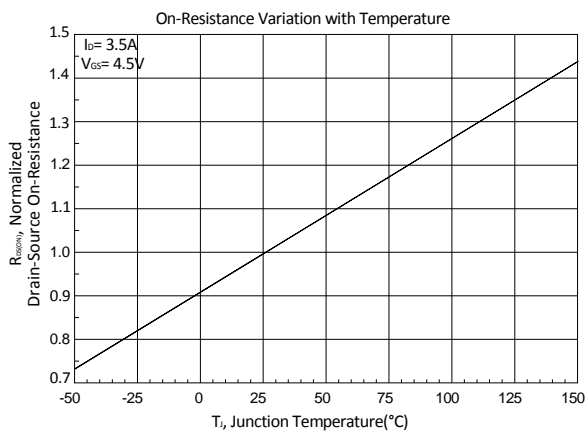
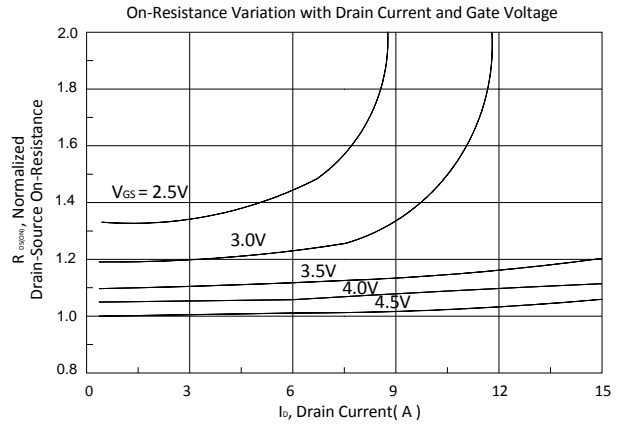
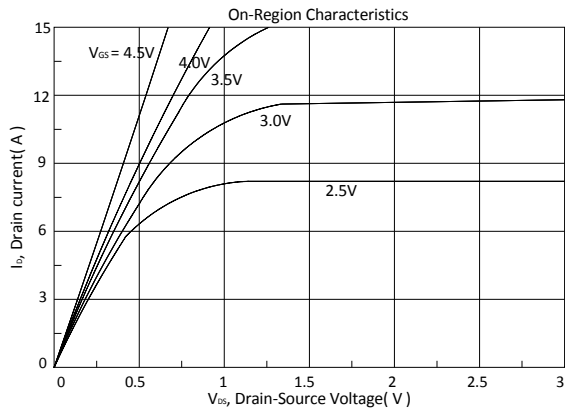
¹Pulse test : Pulse Width $\leq 300\ \mu\text{sec}$, Duty Cycle $\leq 2\%$.

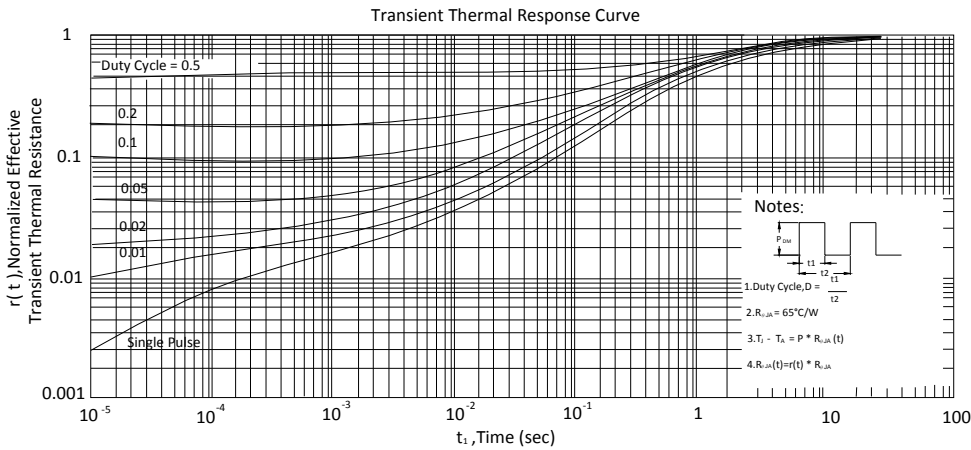
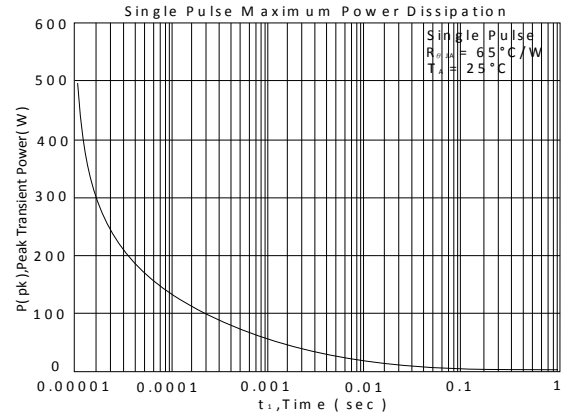
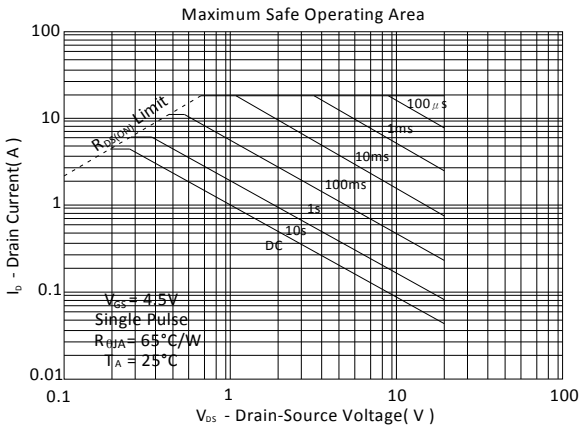
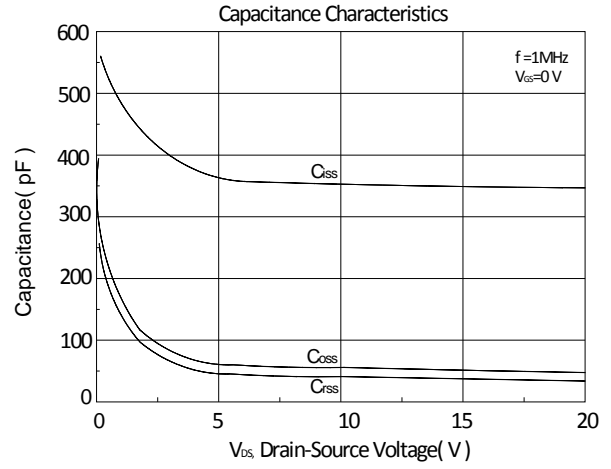
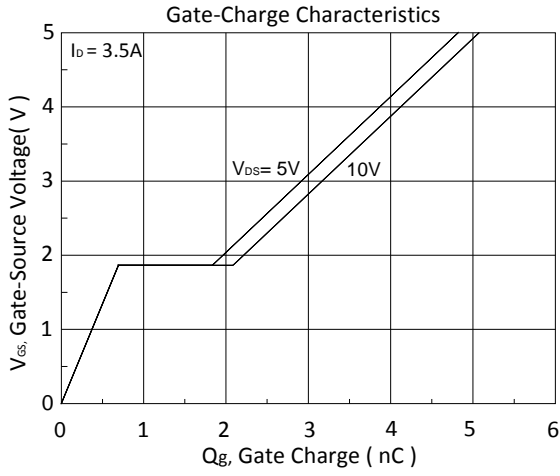
²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.



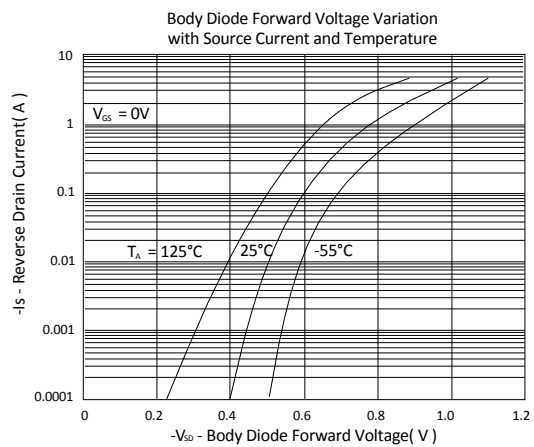
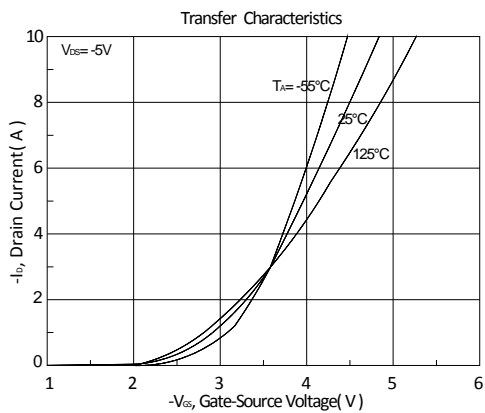
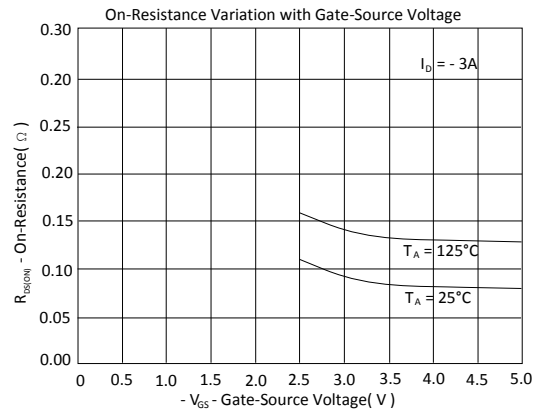
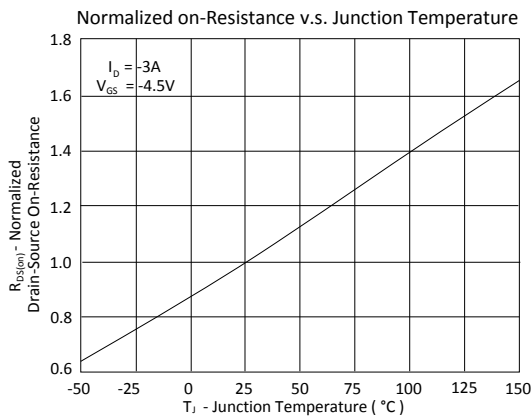
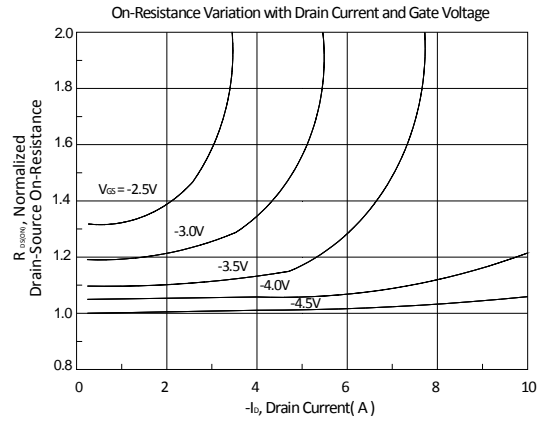
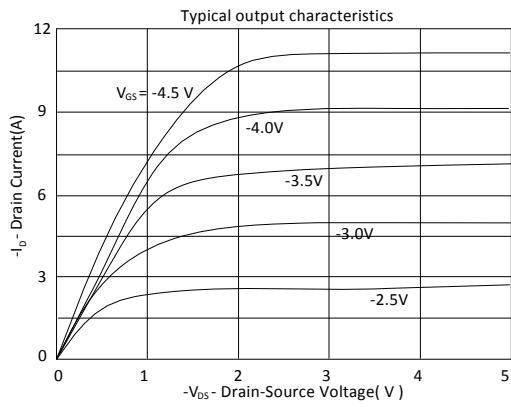
N-Channel

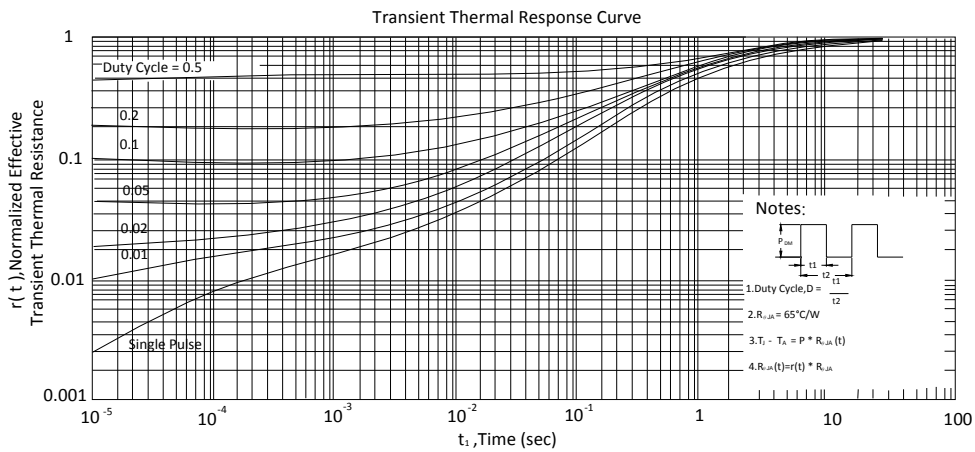
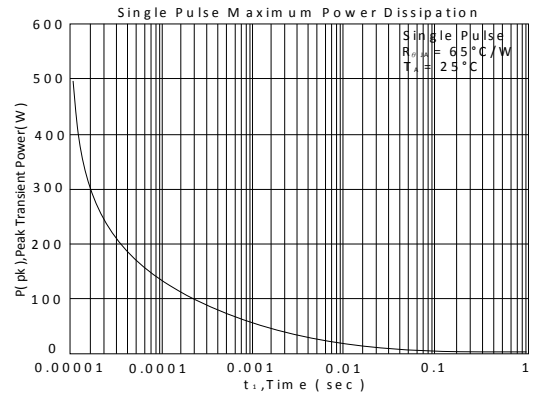
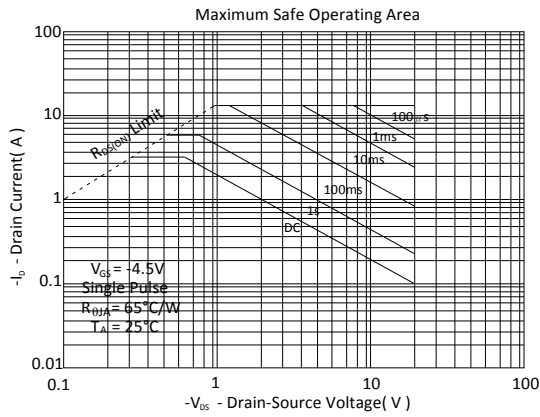
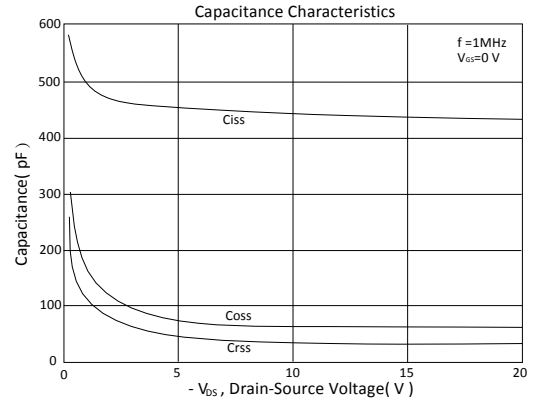
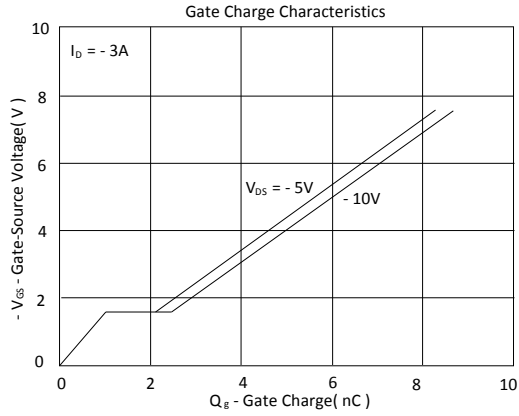






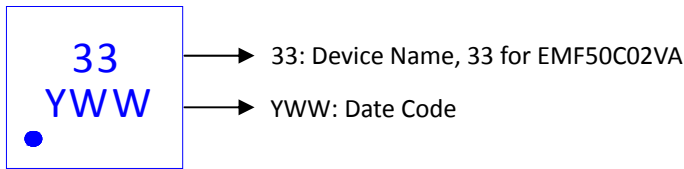
P-Channel



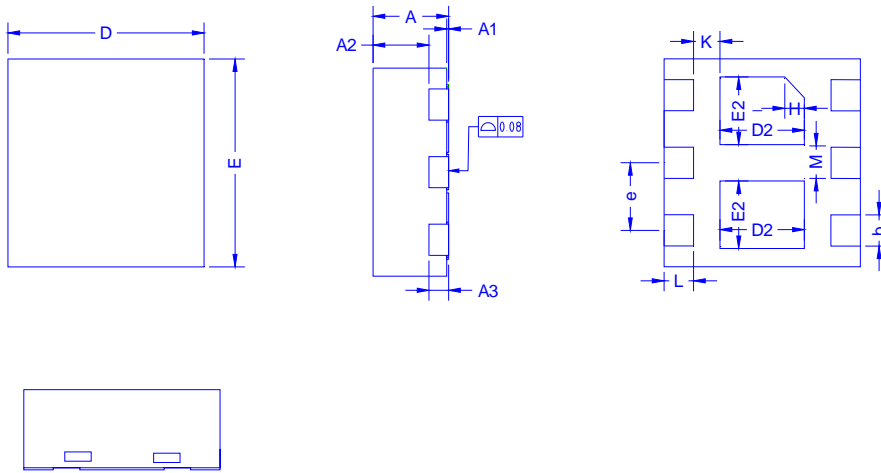


Ordering & Marking Information:

Device Name: EMF50C02VA for EDFN 2 x 2



Outline Drawing



Dimension in mm

Dimension	A	A1	A2	A3	b	D	E	D2	E2	e	H	K	L	M
Min.	0.70	0.00	0.50	0.20 REF	0.25	1.90	1.90	0.76	0.55	0.55	0.20 REF	0.17	0.25	0.25
Max.	0.80	0.05	0.60		0.35	2.10	2.10	0.96	0.75	0.75		0.37	0.35	0.45

Recommended minimum pads

